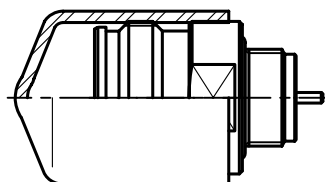
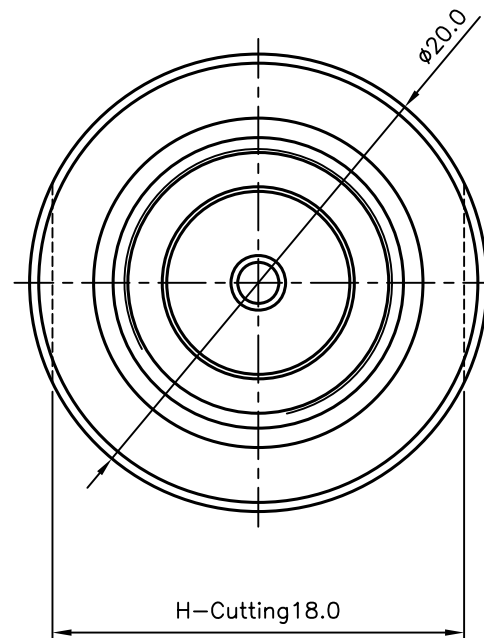
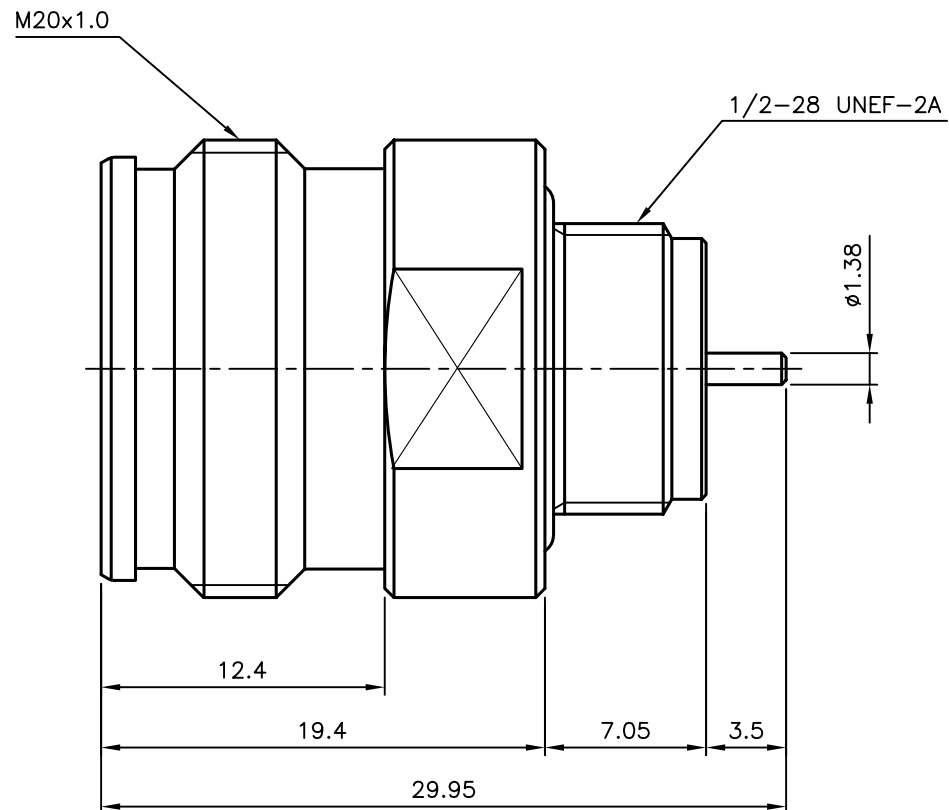


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2020. 07. 29.



- 핀 조립후 변색방지를 위해 Dust cap을 끼워줄 것
- 가급적 핀 조립은 출하 및 조립시 작업 요망 (변색방지)

6	DUST CAP	1	SILICONE RUB	—	DGK00224-N/1
5	GASKET	1	SILICONE RUB	—	DGK00036-N/1
4	JACK	1	MBsBD C3604BD-F	Silver Plate (3 μ m)	DJA00228-5/6
3	INSULATOR	1	TEFLON	—	DIN02769-N/2
2	CONTACT	1	BeCu C17300	Silver Plate (3 μ m)	DCT03695-5/4
1	BODY	1	MBsBD C3604BD-F	binary alloy(SU) (이원합금)	DBD04639-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 07. 29.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY		
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE 4.3-10 DIN50 SOLDER END JB (F/F)
		DRAWN BY	I.C.KIM	
FINISH		SCALE	UNIT	A4 DWG NO. CN03942-7/1 REVISION I R SHEET 1 of 1
		2/1	mm	